

A

B

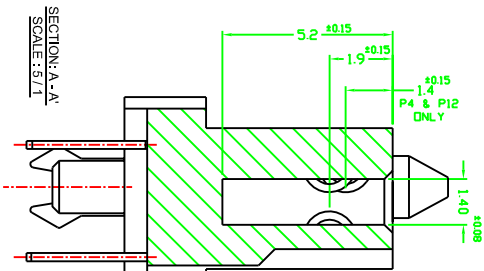
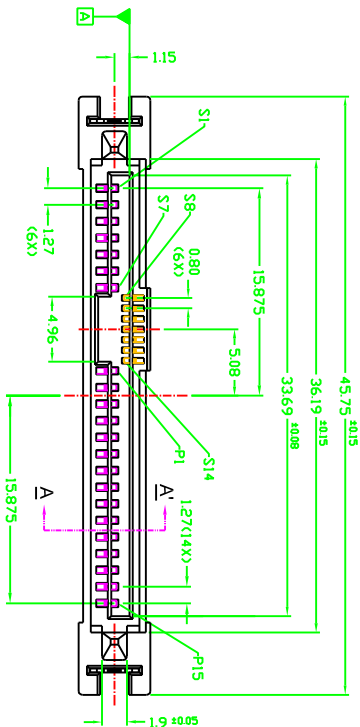
C

U

E

CUSTOMER DRAWING

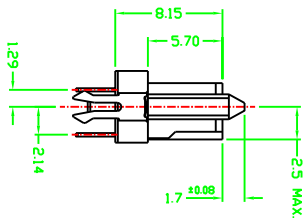
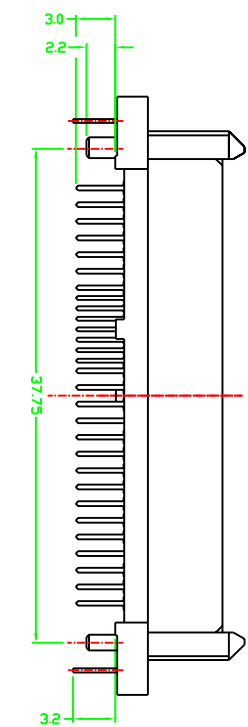
REVISIONS			DATE	APPROVED
SYM	ECN No.	DESCRIPTION		
AX1			03/25/2005	Sommy



- NOTES:
1. MATERIALS:
HOUSING : THERMAL TEMPERATURE RESIN GLASS FILLED, UL94-V0; COLOR : BLACK .
TERMINAL: COPPER ALLOY,
BOARD LOCK: COPPER ALLOY.

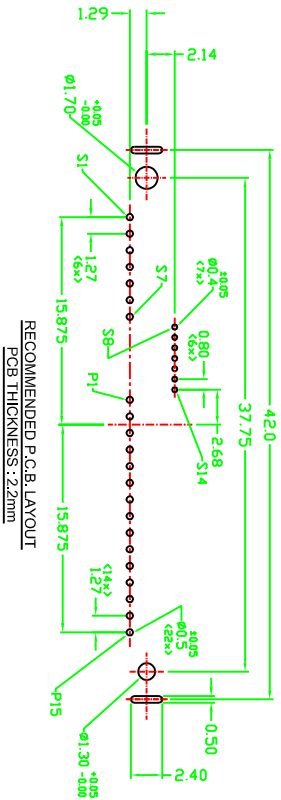
2. PLATING:
TERMINAL:
UNDER PLATING : NICKEL 50U" MIN. OVERALL.
CONTACT AREA : GOLD 30 U" MIN.
SOLDER TAIL AREA : Sn / Cu 80U" MIN.

BOARD LOCK:
Sn / Cu 100U" MIN.OVER UNDER-PLATED NICKEL 50U" MIN.

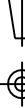


3. CONNECTOR PIN ASSIGNMENTS

S1 -	GROUND	P1 -	3.3V
S2 -	A+	P2 -	3.3V
S3 -	A-	P3 -	3.3V
S4 -	GROUND	P4 -	GROUND
S5 -	B+	P5 -	GROUND
S6 -	B+	P6 -	GROUND
S7 -	GROUND	P7 -	5V
S8 -	GROUND	P8 -	5V
S9 -	A+	P9 -	5V
S10 -	A-	P10 -	GROUND
S11 -	GROUND	P11 -	GROUND
S12 -	B+	P12 -	GROUND
S13 -	B+	P13 -	12V
S14 -	GROUND	P14 -	12V
		P15 -	12V



RECOMMENDED P.C.B. LAYOUT
PCB THICKNESS : 2.2mm

APPROVALS		DATE		TC&C Electronics Co.,Ltd			
DRAWN		03/25/2005					
CHECKED							
APPROVED							
TITLE				2 ROW SAS-29P DIP TYPE CONNECTOR			
		UNIT		SCALE N.A.		PART NO.	
MM				SHEET 1 OF 1		DRAWING NO.	
						REV. AX1	